## MM78C29,MM78C30,MM88C29,MM88C30

MM78C29 MM88C29 Quad Single-Ended Line Driver MM78C30 MM88C30 Dual Differential Line Driver



Literature Number: SNOS351A



## MM78C29/MM88C29 Quad Single-Ended Line Driver MM78C30/MM88C30 Dual Differential Line Driver

## **General Description**

The MM78C30/MM88C30 is a dual differential line driver that also performs the dual four-input NAND or dual four-input AND function. The absence of a clamp diode to  $V_{\rm CC}$  in the input protection circuitry of the MM78C30/MM88C30 allows a CMOS user to interface systems operating at different voltage levels. Thus, a CMOS digital signal source can operate at a  $V_{\rm CC}$  voltage greater than the  $V_{\rm CC}$  voltage of the MM78C30 line driver. The differential output of the MM78C30/MM88C30 eliminates ground-loop errors.

The MM78C29/MM88C29 is a non-inverting single-wire transmission line driver. Since the output ON resistance is a low  $20\Omega$  typ., the device can be used to drive lamps, relays, solenoids, and clock lines, besides driving data lines.

## **Features**

■ Wide supply voltage range

3V to 15V 0.45 V<sub>CC</sub> (typ.)

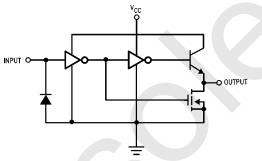
■ High noise immunity

20Ω (typ.)

■ Low output ON resistance

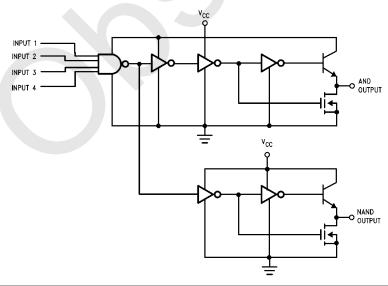
## **Logic Diagrams**

### 1/4 MM78C29/MM88C29



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### 1/2 MM78C30/MM88C30



## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin (Note 1)  $$-0.3\mbox{V to V}_{\mbox{CC}}$ + 16\mbox{V}$ 

Operating Temperature Range MM78C29/MM78C30

Storage Temperature  $-65^{\circ}\text{C to } + 150^{\circ}\text{C}$ 

Power Dissipation (PD)

Dual-In-Line 700 mW Small Outline 500 mW 

## DC Electrical Characteristics Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
смоѕ то смо	os		•			
V <sub>IN(1)</sub>	Logical "1" Input Voltage	$V_{CC} = 5V$ $V_{CC} = 10V$	3.5 8			V
V <sub>IN(0)</sub>	Logical "0" Input Voltage	$V_{CC} = 5V$ $V_{CC} = 10V$			1.5 2	<b>&gt;</b> >
I <sub>IN(1)</sub>	Logical "1" Input Current	$V_{CC} = 15V, V_{IN} = 15V$		0.005	1	μΑ
I <sub>IN(0)</sub>	Logical "0" Input Current	$V_{CC} = 15V, V_{IN} = 0V$	-1	-0.005		μΑ
Icc	Supply Current	$V_{CC} = 5V$		0.05	100	mA
UTPUT DRIV	E					
ISOURCE	Output Source Current MM78C29/MM78C30	$V_{OUT} = V_{CC} - 1.6V,$ $V_{CC} \ge 4.5V, T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-57 -32	-80 -50		mA mA
	MM88C29/MM88C30	$V_{OUT} = V_{CC} - 1.6V,$ $V_{CC} \ge 4.75V, T_j = 25^{\circ}C$ $T_j = 85^{\circ}C$	-47 -32	-80 -60		mA mA
	MM78C29/MM88C29 MM78C30/MM88C30	$V_{OUT} = V_{CC} - 0.8V$ $V_{CC} \ge 4.5V$	-2	-20		mA
ISINK	Output Sink Current MM78C29/MM78C30	$V_{OUT} = 0.4V, V_{CC} = 4.5V,$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	11 8	20 14		mA mA
		$V_{OUT} = 0.4V$ , $V_{CC} = 10V$ , $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	22 16	40 28		mA mA
	MM88C29/MM88C30	$V_{OUT} = 0.4V, V_{CC} = 4.75V, \ T_j = 25^{\circ}C \ T_j = 85^{\circ}C$	9.5 8	22 18		mA mA
		$V_{OUT} = 0.4V, V_{CC} = 10V,$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	19 15.5	40 33		mA mA
ISOURCE	Output Source Resistance MM78C29/MM78C30	$V_{OUT} = V_{CC} - 1.6V,$ $V_{CC} \ge 4.5V, T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$		20 32	28 50	$\Omega \Omega$
	MM88C29/MM88C30	$V_{OUT} = V_{CC} - 1.6V,$ $V_{CC} \ge 4.75V, T_j = 25^{\circ}C$ $T_j = 85^{\circ}C$		20 27	34 50	$\Omega$

## **DC Electrical Characteristics**

Min/Max limits apply across temperature range, unless otherwise noted (Continued)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
OUTPUT DRIV	'E (Continued)					
I <sub>SINK</sub>	Output Sink Resistance MM78C29/MM78C30	$V_{OUT} = 0.4V, V_{CC} = 4.50V,$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$		20 28	36 50	$\Omega \Omega$
		$V_{OUT} = 0.4V, V_{CC} = 10V, \ T_j = 25^{\circ}C \ T_j = 125^{\circ}C$		10 14	18 25	$\Omega$
	MM88C29/MM88C30	$V_{OUT} = 0.4V, V_{CC} = 4.75V, \ T_j = 25^{\circ}C \ T_j = 85^{\circ}C$		18 22	41 50	Ω
		$\begin{aligned} & V_{OUT} = 0.4V, V_{CC} = 10V, \\ & T_j = 25^{\circ}C \\ & T_j = 85^{\circ}C \end{aligned}$		10 12	21 26	$\Omega$
	Output Resistance Temperature Coefficient Source Sink			0.55 0.40		%/°C %/°C
$ heta_{\sf JA}$	Thermal Resistance MM78C29/MM78C30 (D-Package)			100		°C/W
	MM88C29/MM88C30 (N-Package)			150		°C/W

## **AC Electrical Characteristics\*** T<sub>A</sub> = 25°C, C<sub>L</sub> = 50 pF

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t <sub>pd</sub>	Propagation Delay Time to Logical "1" or "0"	(See Figure 2)				
	MM78C29/MM88C29	$V_{CC} = 5V$		80	200	ns
		$V_{CC} = 10V$		35	100	ns
	MM78C30/MM88C30	$V_{CC} = 5V$		110	350	ns
		$V_{CC} = 10V$		50	150	ns
t <sub>pd</sub>	Differential Propagation Delay Time to Logical "1" or "0"	$R_L = 100\Omega, C_L = 5000 \text{ pF}$ (See <i>Figure 1</i> )				
	MM78C30/MM88C30	$V_{CC} = 5V$			400	ns
		$V_{CC} = 10V$			150	ns
C <sub>IN</sub>	Input Capacitance					
	MM78C29/MM88C29	(Note 3)		5.0		pF
	MM78C30/MM88C30	(Note 3)		5.0		pF
$C_{PD}$	Power Dissipation Capacitance					
	MM78C29/MM88C29	(Note 3)		150		pF
	MM78C30/MM88C30	(Note 3)		200		pF

<sup>\*</sup>AC Parameters are guaranteed by DC correlated testing.

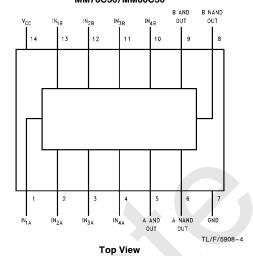
Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Capacitance is guaranteed by periodic testing.

Note 3: C<sub>PD</sub> determines the no load AC power consumption of any CMOS device. For complete explanation see 54C/74C Family Characteristics application note AN-90 (CMOS Logic Databook).

# **Connection Diagrams Dual-In-Line Package** MM78C29/MM88C29

#### **Dual-In-Line Package** MM78C30/MM88C30



**Top View** Order Number MM88C29M or MM88C29N

 $OUT_2$ 

Order Number MM88C30M or MM88C30N

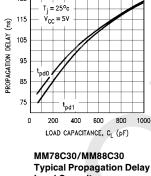
For Complete Military 883 Specifications, see RETS Data Sheet. Order Number MM78C29J/883, MM78C29W/883, MM78C30J/883 or MM78C30W/883

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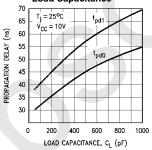
OUT<sub>4</sub>

## **Typical Performance Characteristics**

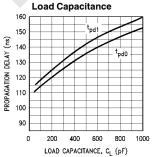
MM78C29/MM88C29 Typical Propagation Delay vs **Load Capacitance** 



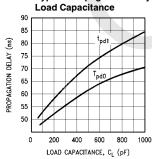
MM78C29/MM88C29 Typical Propagation Delay vs **Load Capacitance** 



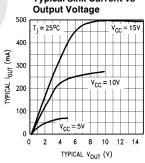
MM78C30/MM88C30 Typical Propagation Delay vs



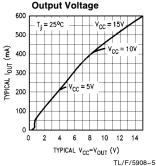
Typical Propagation Delay vs

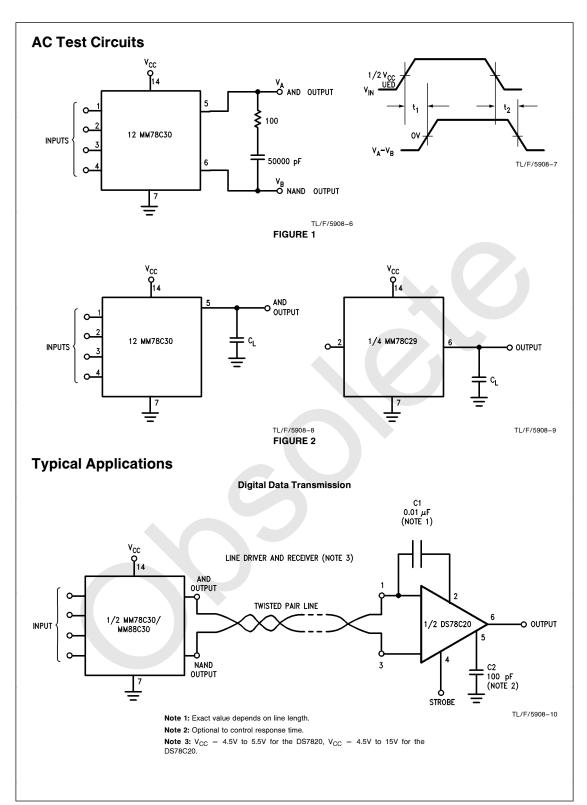


**Typical Sink Current vs** 

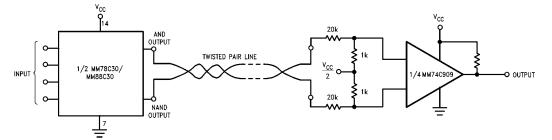


**Typical Source Current vs** 

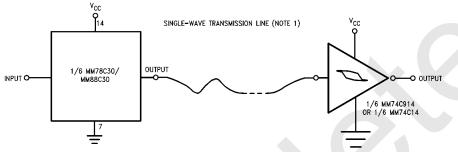




## Typical Applications (Continued)



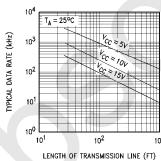
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Note 1: V<sub>CC</sub> is 3V to 15V

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## Typical Data Rate vs Transmission Line Length

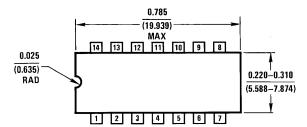


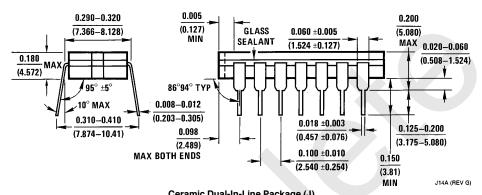
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Note 1: The transmission line used was #22 gauge unshielded twisted pair (40k termination).

Note 2: The curves generated assume that both drivers are driving equal lines, and that the maximum power is 500 mW/package.

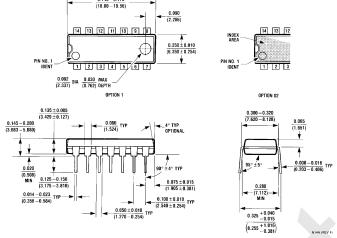
## Physical Dimensions inches (millimeters)





Ceramic Dual-In-Line Package (J) Order Number MM78C29J, MM78C30J, MM88C29J or MM88C30J NS Package Number J14A

## Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N) Order Number MM78C29N, MM78C30N, MM88C29N or MM88C30N NS Package Number N14A

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